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APPLICATION N	NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/706,978		11/14/2003	Tatsuya Arao	0756-7219	0756-7219 7501	
31780	7590	11/14/2005		EXAM	EXAMINER	
ERIC ROBINSON PMB 955				BOOTH, RICHARD A		
	, DUTHBANI	K ST.		ART UNIT	ART UNIT PAPER NUMBER	
POTOM	TOMAC FALLS, VA 20165			2812		
				DATE MAIL ED. 11/14/200	•	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)						
	10/706,978	ARAO ET AL.	(gra					
Office Action Summary	Examiner	Art Unit						
	Richard A. Booth	2812						
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with	the correspondence ad	dress					
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D  - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period  - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION ATE OF THIS COMMUNICATION AND A STREET OF THE ATE OF THE OF THE ATE OF THE ATE OF THE ATE OF THE OF THE OF THE ATE OF THE O	ATION.  ly be timely filed  HS from the mailing date of this condition (35 U.S.C. § 133).						
Status								
1) Responsive to communication(s) filed on 16 S	eptember 2005.							
· · · · · · · · · · · · · · · · · · ·	s action is non-final.							
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closed in accordance with the practice under l	•	•						
Disposition of Claims								
4)⊠ Claim(s) <u>1-21</u> is/are pending in the application.								
4a) Of the above claim(s) is/are withdrawn from consideration.								
5) Claim(s) is/are allowed.								
6)⊠ Claim(s) <u>1-21</u> is/are rejected.								
7) Claim(s) is/are objected to.	•							
8) Claim(s) are subject to restriction and/o	or election requirement.							
Application Papers			•					
	Ar.							
9) The specification is objected to by the Examine		, the Evaminer						
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.								
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).								
11) The oath or declaration is objected to by the E	xaminer. Note the attached t	Office Action of form P1	U-152.					
Priority under 35 U.S.C. § 119								
<ul> <li>12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority document</li> <li>2. Certified copies of the priority document</li> <li>3. Copies of the certified copies of the priority application from the International Burea</li> <li>* See the attached detailed Office action for a list</li> </ul>	ts have been received. ts have been received in Apprity documents have been re u (PCT Rule 17.2(a)).	plication No eceived in this National	Stage					
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date 0905, 0104.		mmary (PTO-413) /Mail Date ormal Patent Application (PTC	O-152)					

## **DETAILED ACTION**

# Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 5-6 are rejected under 35 U.S.C. 102(b) as being anticipated by Kensaku, JP 11-204433.

Kensaku shows the invention as claimed including a method for fabricating a semiconductor device comprising: forming a semiconductor film having an amorphous structure over a substrate; and irradiating the semiconductor film with an excimer laser beam in a linear or rectangular shape while applying ultrasonic vibration to the substrate to crystallize the semiconductor film (see (57) Summary in page 1 of translation).

### Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 7 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kensaku, JP 11-204433.

Kensaku is applied as above but does not expressly disclose wherein the semiconductor device is used for a display device selected from the claimed group. However, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Kensaku so as to use the semiconductor device in one of the claimed display devices because it is well known to those of ordinary skill in the art that semiconductor devices are commonly used in these display devices.

Claims 1-2 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kensaku, JP 11-204433 in view of Tanaka et al., US 2003/0031214 or Tanaka et al, U.S. Patent 6,927,109 or JP 2001-085354.

Kensaku et al. is applied as above but does not expressly disclose irradiating the film while holding an end portion.

Tanaka et al. '214 discloses holding an end potion of a film while irradiating using a device 119 (see fig. 4 and paragraph 0088). Alternatively, Tanaka et al. '109 also discloses holding an end portion of a film using a device 701 (see fig. 6 and col. 8-lines 20-37). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Kensaku so as to include the holding means of Tanaka et al. because in such a way the crystallization can be accurately controlled.

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Claims 3-4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kensaku, JP 11-204433 in view of Tanaka et al, U.S. 2003/0031214.

Kensaku is applied as above but does not expressly disclose holding a substrate over a stage having pores, spouting gases from the pores to float the substrate, and holding an end portion of the substrate.

Tanaka et al. discloses holding a substrate over a stage having pores, spouting gases from the pores to float the substrate, and holding an end portion of the substrate (see, for example, paragraph 0088). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Kensaku so as to hold the substrate as disclosed by Tanaka et al. because such a method allows for adequate controlled crystallization of the semiconductor film.

Claims 11-13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kensaku, JP 11-204433 as applied to claim 7 above, and further in view of Chae, U.S. Patent 5,432,122.

Kensaku is applied as above but does not expressly disclose crystallizing while overlapping a beam spot of the laser beam on the film.

Chae discloses overlapping a beam spot of lasers (see abstract). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Kensaku so as to scan so as to overlap

beam spots on the film because such a method will allow for the manufacture of a high mobility transistor.

Claims 14-17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kensaku, JP 11-204433 in view of Tanaka et al, U.S. 2003/0031214 as applied to claims 3-4 above, and further in view of Liu et al., U.S. Patent 5,147,826.

Kensaku and Tanaka et al. are applied as above but do not expressly disclose crystallizing the semiconductor film by adding a metal element such as nickel for enhancing a crystallization.

Liu et al. discloses adding a metal element for enhancing a crystallization of a semiconductor film (see abstract and col. 4-lines 21-34). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Kensaku modified by Tanaka et al. so as to add a metal element to the semiconductor film because in such a way crystallization can be achieved at a lower temperature.

Claims 18-21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kensaku, JP 11-204433 in view of Chae, U.S. Patent 5,432,122 as applied to claims 11-13 above, and further in view of Liu et al., U.S. Patent 5,147,826.

Kensaku and Chae are applied as above but do not expressly disclose crystallizing the semiconductor film by adding a metal element for enhancing a crystallization.

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Liu et al. discloses adding a metal element for enhancing a crystallization of a semiconductor film (see abstract and col. 4-lines 21-34). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Kensaku modified by Chae so as to add a metal element to the semiconductor film because in such a way crystallization can be achieved at a lower temperature.

Claims 8-10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kensaku, JP 11-204433 in view of Kusumoto et al., U.S. Patent 6,027,960.

Kensaku is applied as above but does not expressly disclose irradiating the semiconductor film in an oxygen atmosphere.

Kusumoto et al. discloses laser annealing in an oxygen atmosphere (see col. 10-lines 21-26). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Kensaku so as to perform laser annealing in an oxygen atmosphere because the crystallinity will be improved.

## Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Richard A. Booth whose telephone number is (571) 272-1668. The examiner can normally be reached on Monday-Thursday from 7:30-6:00.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Lebentritt can be reached on (571) 272-1873. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Richard A. Booth Primary Examiner Art Unit 2812

November 7, 2005